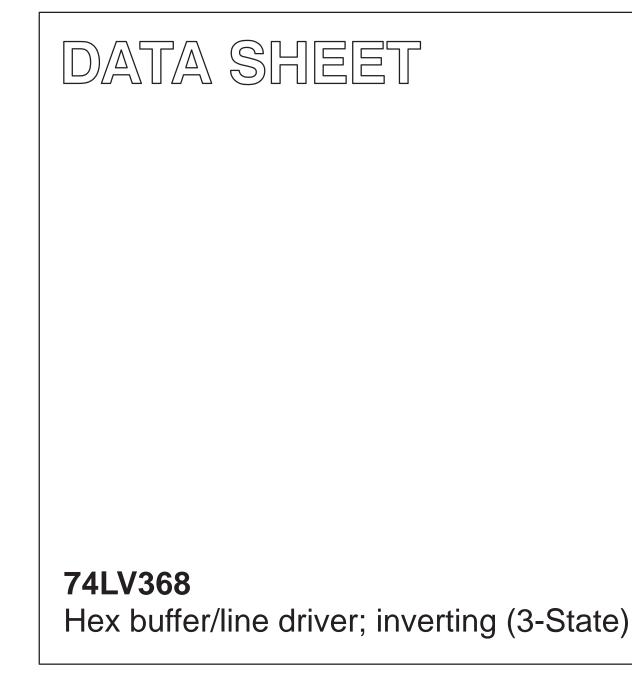
INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Apr 07 IC24 Data Handbook

1998 May 29



74LV368

FEATURES

- Optimized for Low Voltage applications: 1.0 to 3.6V
- Accepts TTL input levels between V_{CC} = 2.7V and V_{CC} = 3.6V
- Typical V_{OLP} (output ground bounce) < 0.8V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) $> 2V @ V_{CC} = 3.3V$, $T_{amb} = 25^{\circ}C$
- Inverting outputs
- Output capability: bus driver
- I_{CC} category: SSI

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

DESCRIPTION

The 74LV368 a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT368.

The 74LV368 is a hex inverting buffer/line driver with 3-state outputs. The 3-state outputs (nY) are controlled by the output enable inputs 10E and 20E. A HIGH on nOE causes the outputs to assume a high impedance OFF-state.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nA to nY	$C_L = 15 pF$ $V_{CC} = 3.3V$	9.0	ns
Cl	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per buffer	Notes 1, 2	30	pF

NOTES:

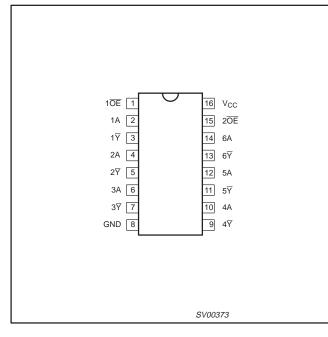
 C_{PD} is used to determine the dynamic power dissipation (P_D in $\mu W)$ 1 $\begin{array}{l} \mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i + \Sigma \left(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o\right) \text{ where:} \\ \mathsf{f}_i = \mathsf{input} \text{ frequency in MHz; } \mathsf{C}_{\mathsf{L}} = \mathsf{output} \text{ load capacitance in pF;} \\ \mathsf{f}_o = \mathsf{output} \text{ frequency in MHz; } \mathsf{V}_{\mathsf{C}\mathsf{C}} = \mathsf{supply voltage in V;} \\ \Sigma \left(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o\right) = \mathsf{sum of the outputs.} \end{array}$ 2 The condition is $\mathsf{V}_{\mathsf{I}} = \mathsf{GND} \text{ to } \mathsf{V}_{\mathsf{C}\mathsf{C}}$

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	–40°C to +125°C	74LV368 N	74LV368 N	SOT38-4
16-Pin Plastic SO	–40°C to +125°C	74LV368 D	74LV368 D	SOT109-1
16-Pin Plastic SSOP Type II	–40°C to +125°C	74LV368 DB	74LV368 DB	SOT338-1
16-Pin Plastic TSSOP Type I	–40°C to +125°C	74LV368 PW	74LV368PW DH	SOT403-1

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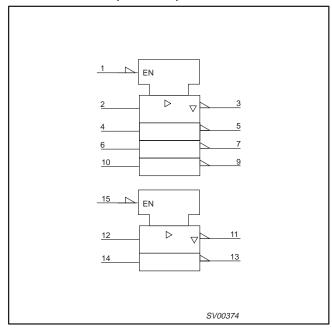




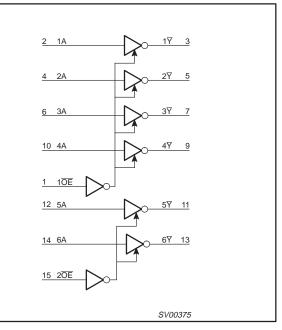
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 15	1 OE to 2 OE	Output enable inputs (active LOW)
2, 4, 6, 10, 12, 14	1A to 6A	Data inputs
3, 5, 7, 9, 11, 13	1Ÿ to 6Ÿ	Bus outputs
8	GND	Ground (0V)
16	V _{CC}	Positive supply voltage

LOGIC SYMBOL (IEEE/IEC)

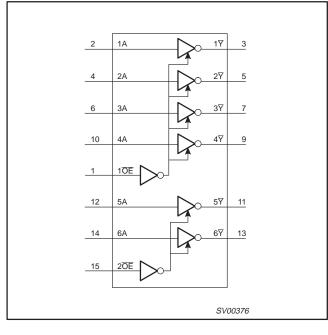


LOGIC SYMBOL



74LV368

FUNCTIONAL DIAGRAM



FUNCTION TABLE

INP	OUTPUT	
nOE	nA	nΫ
L	L	Н
L	Н	L
н	Х	Z

NOTES:

H = HIGH voltage level

L = LOW voltage level

X = Don't care

Z = High impedance OFF-state

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{CC}	DC supply voltage	See Note ¹	1.0	3.3	3.6	V
VI	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V \\ V_{CC} = 2.0V \text{ to } 2.7V \\ V_{CC} = 2.7V \text{ to } 3.6V$			500 200 100	ns/V

NOTES:

1 The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 3.6V.

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134); Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
±I _{IK}	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5 V$	20	mA
±Іок	DC output diode current	$V_{O} < -0.5$ or $V_{O} > V_{CC} + 0.5V$	50	mA
±l _O	DC output source or sink current – bus driver outputs	$-0.5V < V_{O} < V_{CC} + 0.5V$	35	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with –bus driver outputs		70	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package –plastic DIL –plastic mini-pack (SO) –plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

1 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2 The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

			LIMITS					
SYMBOL	PARAMETER	TEST CONDITIONS	-40°C to +85°C			-40°C to +125°C		
			MIN	TYP ¹	MAX	MIN	MAX	1
		$V_{CC} = 1.2V$	0.9			0.9		
V_{IH}	HIGH level Input voltage	$V_{CC} = 2.0V$	1.4			1.4		V
	ge	V _{CC} = 2.7 to 3.6V	2.0			2.0		
		$V_{CC} = 1.2V$			0.3		0.3	
VIL	LOW level Input voltage	$V_{CC} = 2.0V$			0.6		0.6	V
		V _{CC} = 2.7 to 3.6V			0.8		0.8	
		V_{CC} = 1.2V; V_I = V_{IH} or V_{IL} ; $-I_O$ = 100 μ A		1.2				
Varia	HIGH level output	$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	1.8	2.0		1.8		V
V _{OH}	voltage; all outputs	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.5	2.7		2.5		٦ `
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.8	3.0		2.8		1
V _{OH}	HIGH level output voltage; BUS driver outputs	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 8mA$	2.40	2.82		2.20		V
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0				
V	LOW level output	$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	
V _{OL}	voltage; all outputs	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	1 °
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	1
V _{OL}	LOW level output voltage; BUS driver outputs	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 8mA$		0.20	0.40		0.50	V
I _I	Input leakage current	V_{CC} = 3.6V; V_{I} = V_{CC} or GND			1.0		1.0	μA
I _{OZ}	3-State output OFF-state current				5		10	μA
I _{CC}	Quiescent supply current; MSI	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		160	μA
ΔI_{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μA

NOTE:

1 All typical values are measured at $T_{amb} = 25^{\circ}C$.

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Product specification

AC CHARACTERISTICS

GND = 0V; $t_r = t_f = 2.5ns$; $C_L = 50pF$; $R_L = 1K\Omega$

SYMBOL	OL PARAMETER WAVE		BOL PARAMETER WAVEFORM CONDITION		CONDITION	LIMITS -40 to +85 °C			LIMITS -40 to +125 °C		UNIT
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX			
			1.2	-	55	-	-	-			
too too	Propagation delay	Figures, 1, 3	2.0	-	19	36	-	44	ns		
t _{PZL} /t _{PLH}	nA, to nY	rigures, r, s	2.7	-	14	26	-	33	115		
			3.0 to 3.6	-	10 ²	21	-	26			
		ate output ble time Figures, 2, 3	1.2	-	75	-	-	-	ns		
t	3-State output enable time		2.0	-	26	49	-	60			
t _{PZH} /t _{PZL}	$n\overline{OE}$ to $n\overline{Y}$	Figures, 2, 3	2.7	-	19	36	-	44	115		
			3.0 to 3.6	-	14 ²	29	-	35			
			1.2	-	90	-	-	-			
3-State output		2.0	-	32	59	-	70	ns			
'PHZ/'PLZ	t _{PHZ} /t _{PLZ} disable time nOE to nY	Figures, 2, 3	2.7	-	24	44	-	52	115		
			3.0 to 3.6	-	19 ²	36	-	42			

NOTE:

1 Unless otherwise stated, all typical values are at $T_{amb} = 25^{\circ}C$.

2 Typical value measured at $V_{CC} = 3.3V$.

AC WAVEFORMS

 $\begin{array}{l} \mathsf{V}_{\mathsf{M}} = 1.5 \mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7 \mathsf{V} \\ \mathsf{V}_{\mathsf{M}} = 0.5 \mathsf{V}^* \, \mathsf{V}_{\mathsf{CC}} \text{ at } \mathsf{V}_{\mathsf{CC}} < 2.7 \mathsf{V} \\ \mathsf{V}_{\mathsf{OL}} \text{ and } \mathsf{V}_{\mathsf{OH}} \text{ are the typical output voltage drop that occur with the output load.} \\ \mathsf{V}_{\mathsf{X}} = \mathsf{V}_{\mathsf{OL}} + 0.3 \mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7 \mathsf{V} \\ \mathsf{V}_{\mathsf{X}} = \mathsf{V}_{\mathsf{OL}} + 0.1 * \mathsf{V}_{\mathsf{CC}} \text{ at } \mathsf{V}_{\mathsf{CC}} < 2.7 \mathsf{V} \\ \mathsf{V}_{\mathsf{Y}} = \mathsf{V}_{\mathsf{OH}} - 0.3 \mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7 \mathsf{V} \\ \end{array}$

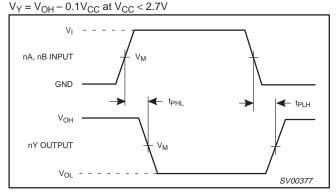


Figure 1.Input (nA) to output $(n\overline{Y})$ propagation delay

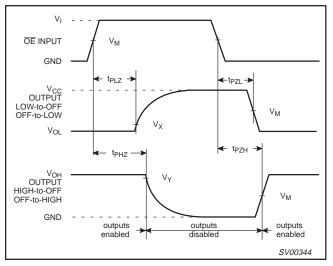


Figure 2. 3-State enable and disable times

Product specification

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TEST CIRCUIT

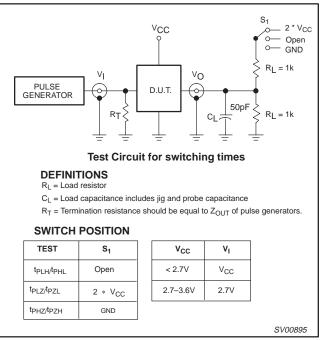
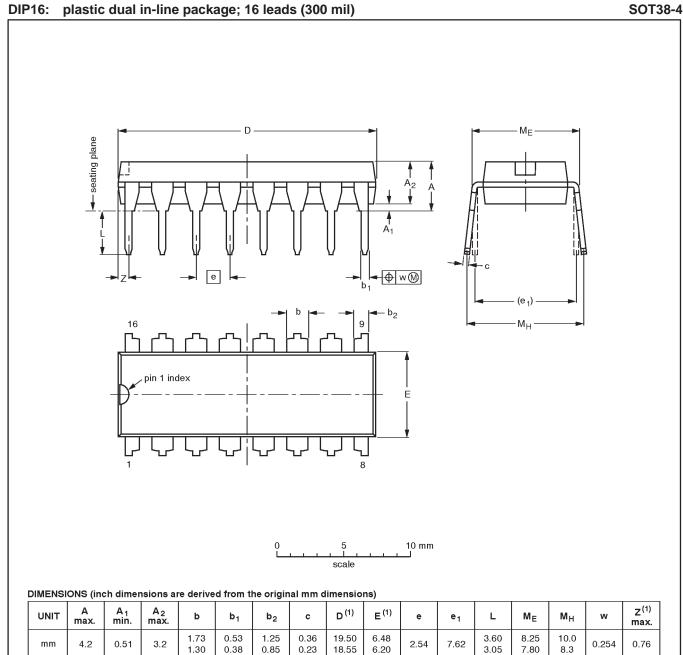


Figure 3. Load circuitry for switching times



inches

0.17

0.020

0.13

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

0.068

0.051

0.021

0.015

0.049

0.033

0.014

0.009

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT38-4						-92-11-17- 95-01-14

8

0.77

0.73

0.26

0.24

0.10

0.30

0.14

0.12

0.32

0.31

0.39

0.33

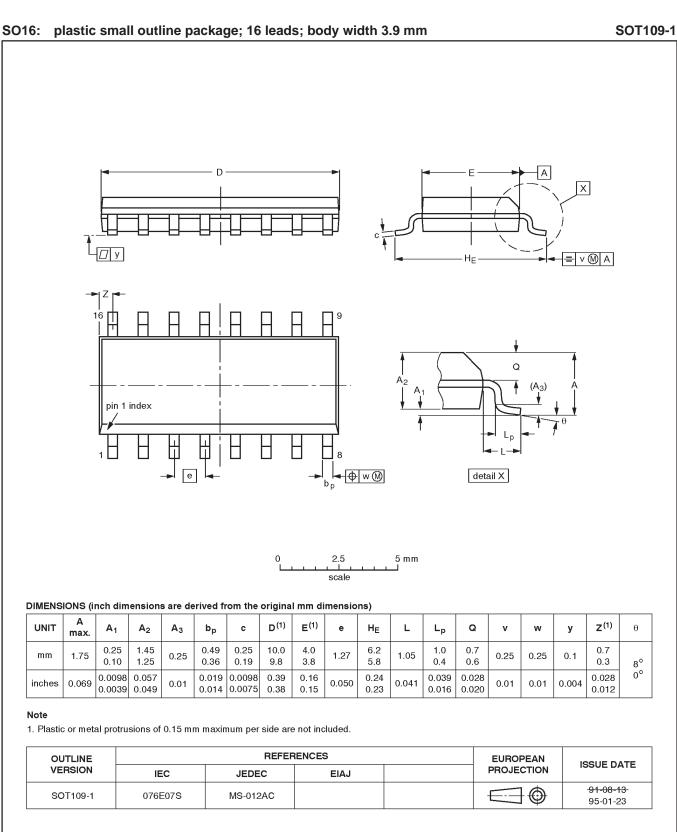
0.01

0.030

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1997 Apr 02

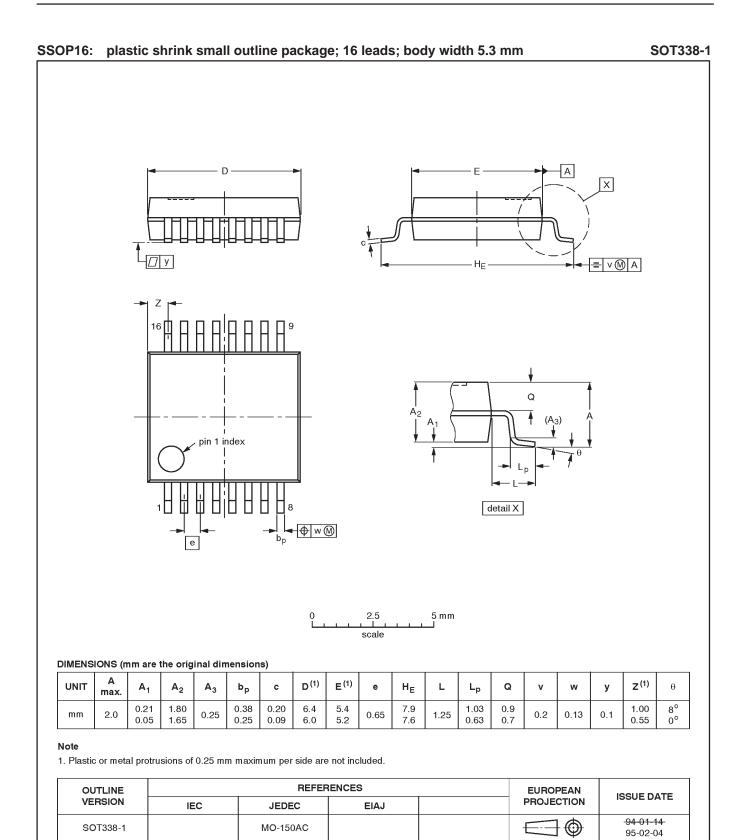
0.0098 0.057 0.019 0.0098 0.39 0.16 0.24 inches 0.069 0.01 0.050 0.0039 0.049 0.014 0.0075 0.38 0.15 0.23 74LV368



Product specification

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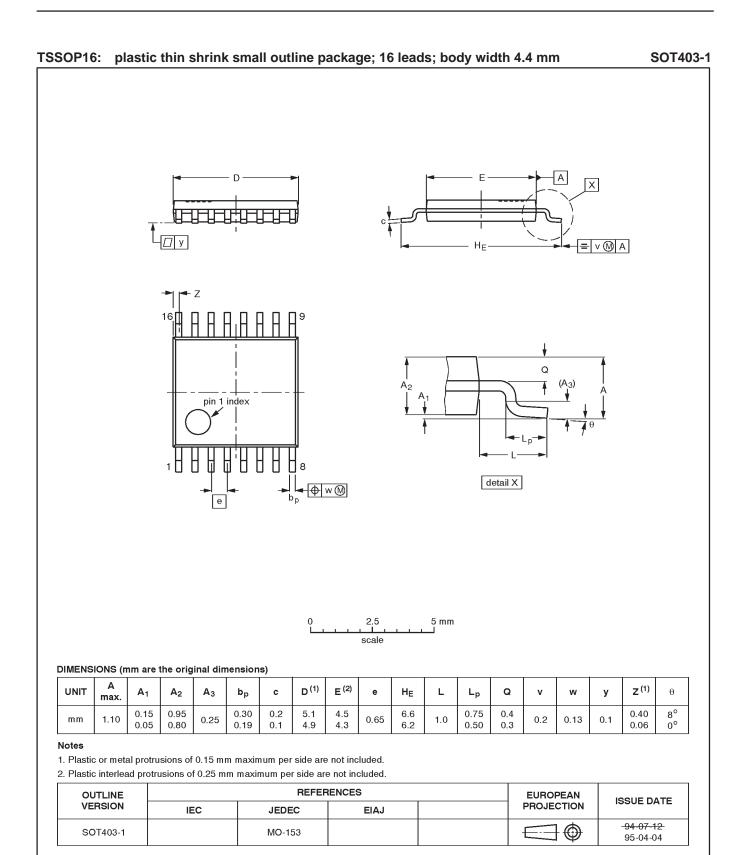
Hex buffer/line driver; inverting (3-State)



Product specification

Hex buffer/line driver; inverting (3-State)

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	DEFINITIONS				
Data Sheet Identification Product Status Definition					
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		This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.			
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